

# 5 V Low Power EIA RS-485 Transceiver

**ADM485** 

## **FEATURES**

Meets EIA RS-485 standard
5 Mbps data rate
Single 5 V supply
-7 V to +12 V bus common-mode range
High speed, low power BiCMOS
Thermal shutdown protection
Short-circuit protection
Driver propagation delay: 10 ns typical
Receiver propagation delay: 15 ns typical
High-Z outputs with power off
Superior upgrade for LTC485

### **APPLICATIONS**

Low power RS-485 systems
DTE/DCE interface
Packet switching
Local area networks (LNAs)
Data concentration
Data multiplexers
Integrated services digital network (ISDN)

## **GENERAL DESCRIPTION**

The ADM485 is a differential line transceiver suitable for high speed bidirectional data communication on multipoint bus transmission lines. It is designed for balanced data transmission and complies with EIA standards RS-485 and RS-422. The part contains a differential line driver and a differential line receiver. Both the driver and the receiver can be enabled independently. When disabled, the outputs are three-stated.

The ADM485 operates from a single 5 V power supply. Excessive power dissipation caused by bus contention or by output shorting is prevented by a thermal shutdown circuit. If during fault conditions, a significant temperature increase is detected in the internal driver circuitry, this feature forces the driver output into a high impedance state.

Up to 32 transceivers can be connected simultaneously on a bus, but only one driver should be enabled at any time. It is important, therefore, that the remaining disabled drivers do not load the bus. To ensure this, the ADM485 driver features high output impedance when disabled and when powered down, which minimizes the loading effect when the transceiver is not being used. The high impedance driver output is maintained over the common-mode voltage range of  $-7~\rm V$  to  $+12~\rm V$ .

#### Rev. F

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### **FUNCTIONAL BLOCK DIAGRAM**

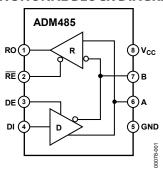


Figure 1.

The receiver contains a fail-safe feature that results in a logic high output state if the inputs are unconnected (floating).

The ADM485 is fabricated on BiCMOS, an advanced mixed technology process combining low power CMOS with fast switching bipolar technology. All inputs and outputs contain protection against ESD; all driver outputs feature high source and sink current capability. An epitaxial layer is used to guard against latch-up.

The ADM485 features extremely fast switching speeds. Minimal driver propagation delays permit transmission at data rates up to 5 Mbps while low skew minimizes EMI interference.

The part is fully specified over the commercial and industrial temperature range and is available in 8-lead PDIP, 8-lead SOIC, and small footprint, 8-lead MSOP packages.

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# **SPECIFICATIONS**

 $V_{\text{CC}}$  = 5 V  $\pm$  5%, all specifications  $T_{\text{MIN}}$  to  $T_{\text{MAX}},$  unless otherwise noted.

Table 1.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
DRIVER					
Differential Output Voltage, VoD			5.0	V	R = ∞, see Figure 20
	2.0		5.0	V	$V_{CC} = 5 \text{ V}, R = 50 \Omega \text{ (RS-422)}, see Figure 20$
	1.5		5.0	V	$R = 27 \Omega$ (RS-485), see Figure 20
$V_{\text{OD3}}$	1.5		5.0	V	$V_{TST} = -7 \text{ V to } +12 \text{ V, see Figure } 21$
$\Delta  V_{OD} $ for Complementary Output States			0.2	V	$R = 27 \Omega$ or 50 Ω, see Figure 20
Common-Mode Output Voltage, Voc			3	V	$R = 27 \Omega$ or $50 \Omega$ , see Figure 20
$\Delta  V_{OD} $ for Complementary Output States			0.2	V	$R = 27 \Omega \text{ or } 50 \Omega$
Output Short-Circuit Current, V <sub>OUT</sub> = High	35		250	mA	$-7 \text{ V} \le \text{V}_0 \le +12 \text{ V}$
Output Short-Circuit Current, Vout = Low	35		250	mA	$-7 \text{ V} \le \text{V}_0 \le +12 \text{ V}$
CMOS Input Logic Threshold Low, V <sub>INL</sub>			8.0	V	
CMOS Input Logic Threshold High, VINH	2.0			V	
Logic Input Current (DE, DI)			±1.0	μΑ	
RECEIVER					
Differential Input Threshold Voltage, V <sub>TH</sub>	-0.2		+0.2	V	$-7 \text{ V} \leq \text{V}_{\text{CM}} \leq +12 \text{ V}$
Input Voltage Hysteresis, ∆V <sub>TH</sub>		70		mV	$V_{CM} = 0 V$
Input Resistance	12			kΩ	$-7 \text{ V} \leq \text{V}_{\text{CM}} \leq +12 \text{ V}$
Input Current (A, B)			1	mA	$V_{IN} = 12 V$
			-0.8	mA	$V_{IN} = -7 \text{ V}$
CMOS Input Logic Threshold Low, V <sub>INL</sub>			8.0	V	
CMOS Input Logic Threshold High, VINH	2.0			V	
Logic Enable Input Current (RE)			±1	μΑ	
CMOS Output Voltage Low, Vol			0.4	V	$I_{OUT} = 4.0 \text{ mA}$
CMOS Output Voltage High, V <sub>OH</sub>	4.0			V	$I_{OUT} = -4.0 \text{ mA}$
Short-Circuit Output Current	7		85	mA	$V_{OUT} = GND \text{ or } V_{CC}$
Three-State Output Leakage Current			±1.0	μΑ	$0.4 \text{ V} \leq \text{V}_{\text{OUT}} \leq 2.4 \text{ V}$
POWER SUPPLY CURRENT					
Icc, Outputs Enabled		1.0	2.2	mA	Digital inputs = GND or V <sub>CC</sub>
I <sub>cc</sub> , Outputs Disabled		0.6	1	mA	Digital inputs = GND or V <sub>CC</sub>

## **TIMING SPECIFICATIONS**

 $V_{\text{CC}}$  = 5 V  $\pm$  5%, all specifications  $T_{\text{MIN}}$  to  $T_{\text{MAX}},$  unless otherwise noted.

Table 2.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
DRIVER					
Propagation Delay Input to Output, t <sub>PLH</sub> , t <sub>PHL</sub>		10	15	ns	$R_{LDIFF} = 54 \Omega$ , $C_{L1} = C_{L2} = 100 \text{ pF}$ , see Figure 22
Driver Output to OUTPUT, t <sub>SKEW</sub>		1	5	ns	$R_{LDIFF} = 54 \Omega$ , $C_{L1} = C_{L2} = 100 pF$ , see Figure 22
Driver Rise/Fall Time, t <sub>R</sub> , t <sub>F</sub>		8	15	ns	$R_{LDIFF} = 54 \Omega$ , $C_{L1} = C_{L2} = 100 \text{ pF}$ , see Figure 22
Driver Enable to Output Valid		10	25	ns	$R_L = 110 \Omega$ , $C_L = 50 pF$ , see Figure 23
Driver Disable Timing	Timing 10 25 ns $R_L = 110 \Omega$ , $C_L = 50 pF$ , see Figure 2.		$R_L = 110 \Omega$ , $C_L = 50 pF$ , see Figure 23		
Matched Enable Switching  tzH - tzL		0	2	ns	$R_L = 110 \Omega$ , $C_L = 50 pF$ , see Figure 23 <sup>1</sup>
Matched Disable Switching  t <sub>HZ</sub> - t <sub>LZ</sub>		0	2	ns	$R_L = 110 \Omega$ , $C_L = 50 pF$ , see Figure 23 <sup>1</sup>
RECEIVER					
Propagation Delay Input to Output, tplh, tphl	8	15	30	ns	$C_L = 15 \text{ pF, see Figure 24}$
Skew  tplh - tphl			5	ns	$C_L = 15$ pF, see Figure 24
Receiver Enable, t <sub>ZH</sub> , t <sub>ZL</sub>		5	20	ns	$C_L = 15 \text{ pF, } R_L = 1 \text{ k}\Omega, \text{ see Figure 25}$
Receiver Disable, t <sub>HZ</sub> , t <sub>LZ</sub>		5	20	ns	$C_L = 15 \text{ pF, } R_L = 1 \text{ k}\Omega, \text{ see Figure 25}$
Tx Pulse Width Distortion		1		ns	
Rx Pulse Width Distortion		1		ns	

 $<sup>^{\</sup>rm 1}\,\mbox{Guaranteed}$  by characterization.

## **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25$ °C, unless otherwise noted.

Table 3.

1 able 3.		
Parameter	Rating	
Vcc	-0.3 V to +7 V	
Inputs		
Driver Input (DI)	$-0.3$ V to $V_{CC}$ + $0.3$ V	
Control Inputs (DE, RE)	$-0.3$ V to $V_{CC} + 0.3$ V	
Receiver Inputs (A, B)	−9 V to +14 V	
Outputs		
Driver Outputs (A, B)	−9 V to +14 V	
Receiver Output	$-0.5  \text{V}$ to $V_{CC} + 0.5  \text{V}$	
Power Dissipation 8-Lead MSOP	900 mW	
$\theta_{JA}$ , Thermal Impedance	206°C/W	
Power Dissipation 8-Lead PDIP	500 mW	
$\theta_{JA}$ , Thermal Impedance	130°C/W	
Power Dissipation 8-Lead SOIC	450 mW	
$\theta_{JA}$ , Thermal Impedance	170°C/W	
Operating Temperature Range		
Commercial Range (J Version)	0°C to 70°C	
Industrial Range (A Version)	−40°C to +85°C	
Storage Temperature Range	−65°C to +150°C	
Lead Temperature (Soldering, 10 sec)	300°C	
Vapor Phase (60 sec)	215°C	
Infrared (15 sec)	220°C	

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**Table 4. Transmitting** 

Inputs		C	Outputs		
DE	DI	В	Α		
1	1	0	1		
1	0	1	0		
0	<b>X</b> <sup>1</sup>	Z <sup>2</sup>	Z <sup>2</sup>		

 $<sup>^{1}</sup>$  X = don't care.

Table 5. Receiving

-			
	RE	Input A – Input B	Output RO
	0	≥ +0.2 V	1
	0	≤ −0.2 V	0
	0	Inputs open	1
_	1	X <sup>1</sup>	$Z^2$

 $<sup>^{1}</sup>$  X = don't care.

## **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

 $<sup>^{2}</sup>$  Z = high impedance.

 $<sup>^{2}</sup>$  Z = high impedance.

# PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

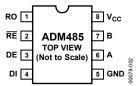


Figure 2. Pin Configuration

## **Table 6. Pin Function Descriptions**

Pin No.	Mnemonic	Function	
1	RO	Receiver Output. When enabled, if A is greater than B by 200 mV, RO is high. If A is less than B by 200 mV, RO is low.	
2	RE	Receiver Output Enable. A low level enables the receiver output, RO. A high level places it in a high impedance state.	
3	DE	Driver Output Enable. A high level enables the driver differential outputs, A and B. A low level places it in a high impedance state.	
4	DI	Driver Input. When the driver is enabled, a logic low on DI forces A low and B high, while a logic high on DI forces A high and B low.	
5	GND	Ground Connection, 0 V.	
6	Α	Noninverting Receiver Input A/Driver Output A.	
7	В	Inverting Receiver Input B/Driver Output B.	
8	V <sub>CC</sub>	Power Supply, 5 V ± 5%.	

## TYPICAL PERFORMANCE CHARACTERISTICS

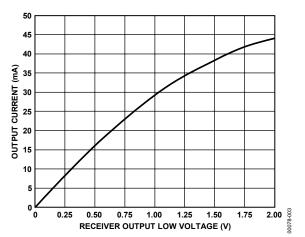


Figure 3. Output Current vs. Receiver Output Low Voltage

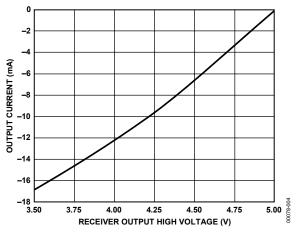


Figure 4. Output Current vs. Receiver Output High Voltage

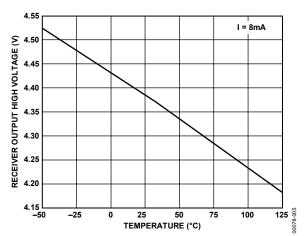


Figure 5. Receiver Output High Voltage vs. Temperature

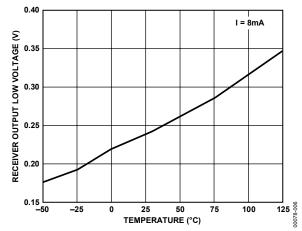


Figure 6. Receiver Output Low Voltage vs. Temperature

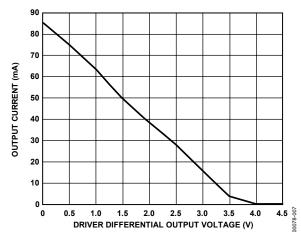


Figure 7. Output Current vs. Driver Differential Output Voltage

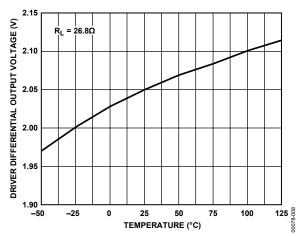


Figure 8. Driver Differential Output Voltage vs. Temperature

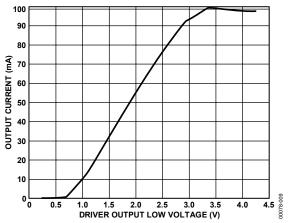


Figure 9. Output Current vs. Driver Output Low Voltage

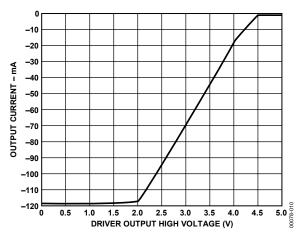


Figure 10. Output Current vs. Driver Output High Voltage

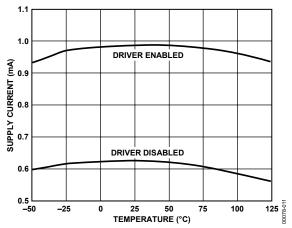


Figure 11. Supply Current vs. Temperature

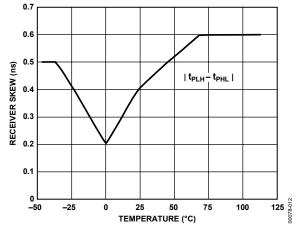


Figure 12. Receiver Skew vs. Temperature

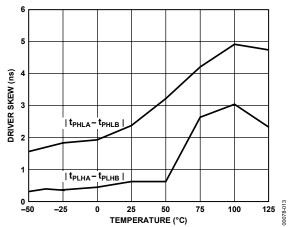


Figure 13. Driver Skew vs. Temperature

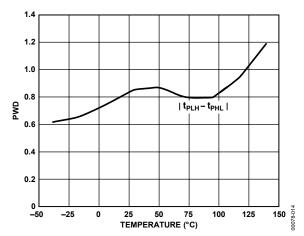


Figure 14. Driver Pulse Width Distortion (PWD) vs. Temperature

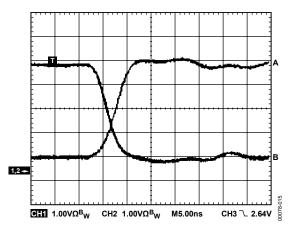


Figure 15. Unloaded Driver Differential Outputs

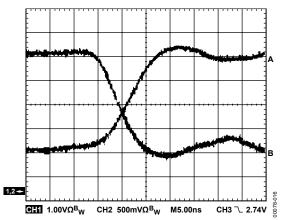


Figure 16. Loaded Driver Differential Outputs

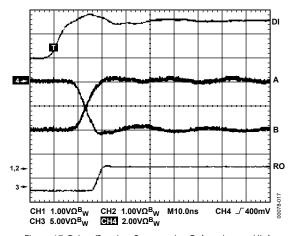


Figure 17. Driver/Receiver Propagation Delays, Low to High

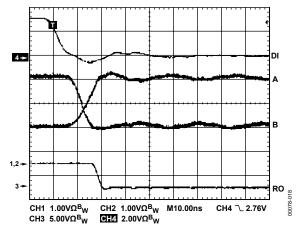


Figure 18. Driver/Receiver Propagation Delays, High to Low

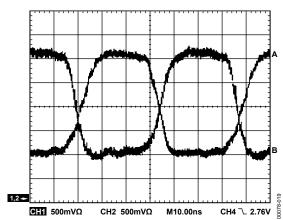


Figure 19. Driver Output at 30 Mbps

# **TEST CIRCUITS**

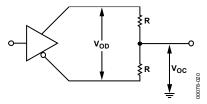


Figure 20. Driver Voltage Measurement

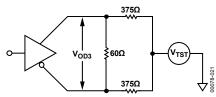


Figure 21. Driver Voltage Measurement

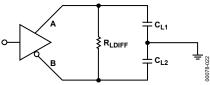


Figure 22. Driver Propagation Delay

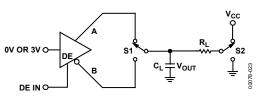


Figure 23. Driver Enable/Disable

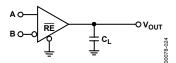


Figure 24. Receiver Propagation Delay

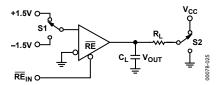


Figure 25. Receiver Enable/Disable

# **SWITCHING CHARACTERISTICS**

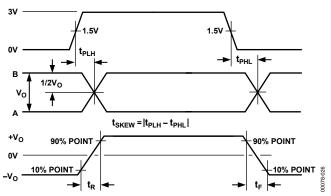


Figure 26. Driver Propagation Delay, Rise/Fall Timing

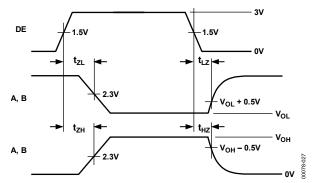


Figure 27. Driver Enable/Disable Timing

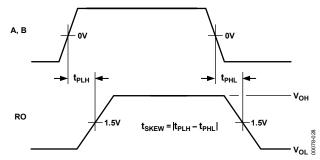


Figure 28. Receiver Propagation Delay

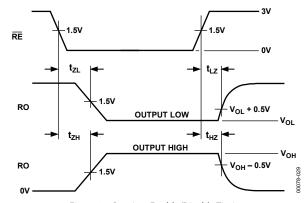


Figure 29. Receiver Enable/Disable Timing

# APPLICATIONS INFORMATION DIFFERENTIAL DATA TRANSMISSION

Differential data transmission is used to reliably transmit data at high rates over long distances and through noisy environments. Differential transmission nullifies the effects of ground shifts and noise signals that appear as common-mode voltages on the line. There are two main standards approved by the EIA that specify the electrical characteristics of transceivers used in differential data transmission.

The RS-422 standard specifies data rates up to 10 MBaud and line lengths up to 4000 ft. A single driver can drive a transmission line with up to 10 receivers.

To cater to true multipoint communications, the RS-485 standard was defined. This standard meets or exceeds all the requirements of RS-422 but also allows for up to 32 drivers and 32 receivers to be connected to a single bus. An extended common-mode range of -7~V to +12~V is defined. The most significant difference between the RS-422 standard and the RS-485 standard is the fact that the drivers can be disabled, thereby allowing more than one (32 in fact) to be connected to a single line. Only one driver should be enabled at a time, but the RS-485 standard contains additional specifications to guarantee device safety in the event of line contention.

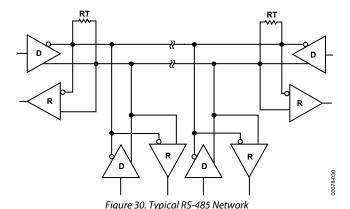
Table 7. Comparison of RS-422 and RS-485 Interface Standards

Tuble 7. Comparison of Ro 122 and Ro 103 interface of and area					
Specification	RS-422	RS-485			
Transmission Type	Differential	Differential			
Maximum Cable Length	4000 ft.	4000 ft.			
Minimum Driver Output Voltage	±2 V	±1.5 V			
Driver Load Impedance	100 Ω	54 Ω			
Receiver Input Resistance	4 kΩ min	12 kΩ min			
Receiver Input Sensitivity	±200 mV	±200 mV			
Receiver Input Voltage Range	−7 V to +7 V	−7 V to +12 V			
No. of Drivers/Receivers per Line	1/10	32/32			

## **CABLE AND DATA RATE**

The transmission line of choice for RS-485 communications is a twisted pair. Twisted pair cable tends to cancel common-mode noise and causes cancellation of the magnetic fields generated by the current flowing through each wire, thereby reducing the effective inductance of the pair.

The ADM485 is designed for bidirectional data communications on multipoint transmission lines. A typical application showing a multipoint transmission network is illustrated in Figure 30. An RS-485 transmission line can have as many as 32 transceivers on the bus. Only one driver can transmit at a particular time, but multiple receivers can be enabled simultaneously.



As with any transmission line, it is important that reflections be minimized. This can be achieved by terminating the extreme ends of the line using resistors equal to the characteristic impedance of the line. Stub lengths of the main line should also be kept as short as possible. A properly terminated transmission line appears purely resistive to the driver.

### THERMAL SHUTDOWN

The ADM485 contains thermal shutdown circuitry that protects the part from excessive power dissipation during fault conditions. Shorting the driver outputs to a low impedance source can result in high driver currents. The thermal sensing circuitry detects the increase in die temperature and disables the driver outputs. The thermal sensing circuitry is designed to disable the driver outputs when a die temperature of 150°C is reached. As the device cools, the drivers are re-enabled at 140°C.

## **PROPAGATION DELAY**

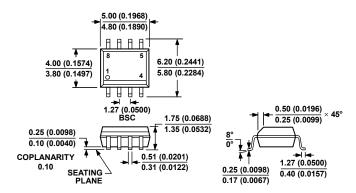
The ADM485 features very low propagation delay, ensuring maximum baud rate operation. The driver is well balanced, ensuring distortion free transmission.

Another important specification is a measure of the skew between the complementary outputs. Excessive skew impairs the noise immunity of the system and increases the amount of electromagnetic interference (EMI).

## **RECEIVER OPEN CIRCUIT, FAIL-SAFE**

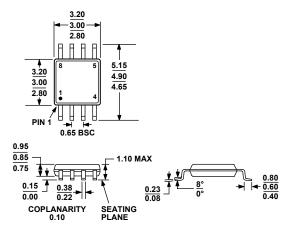
The receiver input includes a fail-safe feature that guarantees a logic high on the receiver when the inputs are open circuit or floating.

## **OUTLINE DIMENSIONS**



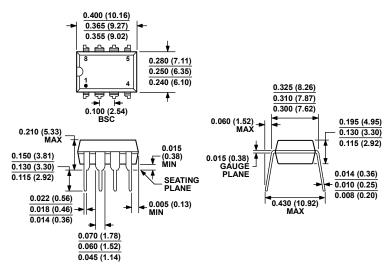
COMPLIANT TO JEDEC STANDARDS MS-012-AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 31. 8-Lead Standard Small Outline Package [SOIC\_N] Narrow Body (R-8) Dimensions shown in millimeters and (inches)



## COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 32. 8-Lead Mini Small Outline Package [MSOP] (RM-8) Dimensions shown in millimeters



#### COMPLIANT TO JEDEC STANDARDS MS-001

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

Figure 33. 8-Lead Plastic Dual In-Line Package [PDIP] Narrow Body (N-8) Dimensions shown in inches and (millimeters)

## **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option	Branding
ADM485AN	-40°C to +85°C	8-Lead PDIP	N-8	
ADM485ANZ <sup>1</sup>	−40°C to +85°C	8-Lead PDIP	N-8	
ADM485AR	−40°C to +85°C	8-Lead SOIC_N	R-8	
ADM485AR-REEL	−40°C to +85°C	8-Lead SOIC_N	R-8	
ADM485ARZ <sup>1</sup>	-40°C to +85°C	8-Lead SOIC_N	R-8	
ADM485ARZ-REEL <sup>1</sup>	−40°C to +85°C	8-Lead SOIC_N	R-8	
ADM485ARM	-40°C to +85°C	8-Lead MSOP	RM-8	M41
ADM485ARM-REEL	-40°C to +85°C	8-Lead MSOP	RM-8	M41
ADM485ARM-REEL7	-40°C to +85°C	8-Lead MSOP	RM-8	M41
ADM485ARMZ <sup>1</sup>	-40°C to +85°C	8-Lead MSOP	RM-8	M41#
ADM485ARMZ-REEL <sup>1</sup>	-40°C to +85°C	8-Lead MSOP	RM-8	M41#
ADM485ARMZ-REEL7 <sup>1</sup>	−40°C to +85°C	8-Lead MSOP	RM-8	M41#
ADM485JN	0°C to 70°C	8-Lead PDIP	N-8	
ADM485JNZ <sup>1</sup>	0°C to 70°C	8-Lead PDIP	N-8	
ADM485JR	0°C to 70°C	8-Lead SOIC_N	R-8	
ADM485JR-REEL	0°C to 70°C	8-Lead SOIC_N	R-8	
ADM485JR-REEL7	0°C to 70°C	8-Lead SOIC_N	R-8	
ADM485JRZ <sup>1</sup>	0°C to 70°C	8-Lead SOIC_N	R-8	
ADM485JRZ-REEL <sup>1</sup>	0°C to 70°C	8-Lead SOIC_N	R-8	
ADM485JRZ-REEL7 <sup>1</sup>	0°C to 70°C	8-Lead SOIC_N	R-8	

 $<sup>^1</sup>$  Z = RoHS Compliant Part, # denotes RoHS compliant product may be top or bottom marked.

# **NOTES**

ADM485
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